## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Nobuyuki Ohtsuka	05/21/2010
Noriyoshi Shimizu	05/24/2010

#### RECEIVING PARTY DATA

Name:	FUJITSU SEMICONDUCTOR LIMITED	
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State/Country:	JAPAN	
Postal Code:	222-0033	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12816704

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**Total Attachments: 1** 

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PATENT REEL: 024549 FRAME: 0532

# **U.S. ASSIGNMENT**

IN CONSIDERATION of the sum of One Dollar (inventor(s) (hereinafter, "ASSIGNOR") by (Insert Name(s) & Address(es) of ASSIGNEE(S))	or 1.00), and or other good and valuable	consideration paid to the unidersigned
FUJITSU SEMICONDUCTOR LIMITED		· · · · · · · · · · · · · · · · · · ·
2-10-23 Shin-Yokohama, Kohoku-ku, Yokohama-shi,	Kanagawa 222-0033 Japan	
(hereinafter, "ASSIGNEE"), the receipt of which is herel ASSIGNEE the entire and exclusive right, title and interesting of Invention)		OR hereby sells, assigns and transfers to
SEMICONDUCTOR DEVICE AND METHOD FOR 1	MANUFACTURING SEMICONDUCTOR	DEVICE
relating to International Patent Application PCT/JP <u>200</u> executed on even date herewith or, if not so executed, wa		for Letters Patent of the United States was
(a) executed on	; (Insert date of execution of applic	cation, if not concurrent)
(b) filed on;	Assignee's attorney is hereby data, when known.	authorized to insert in (b) the specified
and to said application and all Letters Patent(s) of the Un substitute, reissue or reexamination application based the including any extensions thereof (collectively, hereinafte	eon, for the full term or terms for which the r, "said application(s) and Letters Patent(s)"	said Letters Patent(s) may be granted and
The ASSIGNOR agree(s), when requested by said AS which the ASSIGNEE may deem necessary, desirable or including in the preparation and prosecution of said appli reexamination, or public use proceeding, and in any litigat acts to include but not be limited to executing all papers, sworn testimony, and obtaining and producing evidence.	expedient, for securing, maintaining and en cation(s) and the issuance of said Letters Pa ion or other legal proceeding which may ari	forcing protection for said invention, stent(s), in any interference, reissue, se or be declared in relation to same, such
IN WITNESS WHEREOF, the undersigned inventor(s	s) has (have) affixed his/her/their signature(	s).
1) Nobujuhi Ohtauka	Nobuyuki Ohtsuka (Type Name)	
2) Norigoski Skinson (Signature)	Noriyoshi Shimizu (Type Name)	May 24, 2010
3)(Signature)	(Type Name)	(Date)
4)( Signature)	(Type Name)	(Date)
5) (Signature)	(Type Name)	(Date)

**RECORDED: 06/17/2010** 

PATENT REEL: 024549 FRAME: 0533